Atmel®

8-bit AVR Microcontroller

ATmega32A

DATASHEET SUMMARY

Introduction

The Atmel® ATmega32A is a low-power CMOS 8-bit microcontroller based on the AVR® enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega32A achieves throughputs close to 1MIPS per MHz. This empowers system designer to optimize the device for power consumption versus processing speed.

Features

- High-performance, Low-power Atmel AVR 8-bit Microcontroller
- Advanced RISC Architecture
  - 131 Powerful Instructions - Most Single-clock Cycle Execution
  - 32 × 8 General Purpose Working Registers
  - Fully Static Operation
  - Up to 16MIPS Throughput at 16MHz
  - On-chip 2-cycle Multiplier
- High Endurance Non-volatile Memory segments
  - 32Kbytes of In-System Self-programmable Flash program memory
  - 1024Bytes EEPROM
  - 2Kbytes Internal SRAM
  - Write/Erase cycles: 10,000 Flash/100,000 EEPROM
  - Data retention: 20 years at 85°C/100 years at 25°C[(1)]
  - Optional Boot Code Section with Independent Lock Bits
    - In-System Programming by On-chip Boot Program
    - True Read-While-Write Operation
  - Programming Lock for Software Security
- JTAG (IEEE std. 1149.1 Compliant) Interface
  - Boundary-scan Capabilities According to the JTAG Standard
  - Extensive On-chip Debug Support
  - Programming of Flash, EEPROM, Fuses and Lock Bits through the JTAG Interface
- Atmel QTouch® library support

This is a summary document. A complete document is available on our Web site at www.atmel.com

- Capacitive touch buttons, sliders and wheels
  - Atmel QTouch and QMatrix acquisition
  - Up to 64 sense channels
- Peripheral Features
  - Two 8-bit Timer/Counters with Separate Prescalers and Compare Modes
  - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
  - Real Time Counter with Separate Oscillator
  - Four PWM Channels
  - 8-channel, 10-bit ADC
    - 8 Single-ended Channels
    - 7 Differential Channels in TQFP Package Only
    - 2 Differential Channels with Programmable Gain at 1x, 10x, or 200x
  - Byte-oriented Two-wire Serial Interface
  - Programmable Serial USART
  - Master/Slave SPI Serial Interface
  - Programmable Watchdog Timer with On-chip Oscillator
  - On-chip Analog Comparator
- Special Microcontroller Features
  - Power-on Reset and Programmable Brown-out Detection
  - Internal Calibrated RC Oscillator
  - External and Internal Interrupt Sources
  - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby, and Extended Standby
- I/O and Packages
  - 32 Programmable I/O Lines
  - 40-pin PDIP, 44-lead TQFP, and 44-pad QFN/MLF
- Operating Voltages
  - 2.7 - 5.5V
- Speed Grades
  - 0 - 16MHz
- Power Consumption at 1MHz, 3V, 25°C
  - Active: 0.6mA
  - Idle Mode: 0.2mA
  - Power-down Mode: < 1µA

Table of Contents

1. Description

The AVR core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATmega32A provides the following features: 32Kbytes of In-System Programmable Flash Program memory with Read-While-Write capabilities, 1024bytes EEPROM, 2048bytes SRAM, 32 general purpose I/O lines, 32 general purpose working registers, a JTAG interface for Boundary-scan, On-chip Debugging support and programming, three flexible Timer/Counters with compare modes, Internal and External Interrupts, a serial programmable USART, a byte oriented Two-wire Serial Interface, an 8-channel, 10-bit ADC with optional differential input stage with programmable gain (TQFP package only), a programmable Watchdog Timer with Internal Oscillator, an SPI serial port, and six software selectable power saving modes. The Idle mode stops the CPU while allowing the USART, Two-wire interface, A/D Converter, SRAM, Timer/Counters, SPI port, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next External Interrupt or Hardware Reset. In Power-save mode, the Asynchronous Timer continues to run, allowing the user to maintain a timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except Asynchronous Timer and ADC, to minimize switching noise during ADC conversions. In Standby mode, the crystal/resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low-power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run.

The device is manufactured using Atmel's high density nonvolatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed in-system through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The boot program can use any interface to download the application program in the Application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega32A is a powerful microcontroller that provides a highly-flexible and cost-effective solution to many embedded control applications.

The Atmel AVR ATmega32A is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, in-circuit emulators, and evaluation kits.

2. Configuration Summary

Features	ATmega32A
Pin count	44
Flash (KB)	32
SRAM (KB)	2
EEPROM (KB)	1
General Purpose I/O pins	32
SPI	1
TWI (I^2C)	1
USART	1
ADC	10-bit, up to 76.9ksps (15ksps at max resolution)
ADC channels	8
AC propagation delay	Typ 400ns
8-bit Timer/Counters	2
16-bit Timer/Counters	1
PWM channels	4
RC Oscillator	+/-3%
VREF Bandgap	
Operating voltage	2.7 - 5.5V
Max operating frequency	16MHz
Temperature range	-55°C to +125°C
JTAG	Yes

3. Ordering Information

Speed (MHz)	Power Supply	Ordering Code[2]	Package[1]	Operational Range
16	2.7 - 5.5V	ATmega32A-AU ATmega32A-AUR[3] ATmega32A-PU ATmega32A-MU ATmega32A-MUR[3]	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 85°C)
		ATmega32A-AN ATmega32A-ANR[3] ATmega32A-MN ATmega32A-MNR[3]	44A 44A 44M1 44M1	Extended (-40°C to 105°C)[4]

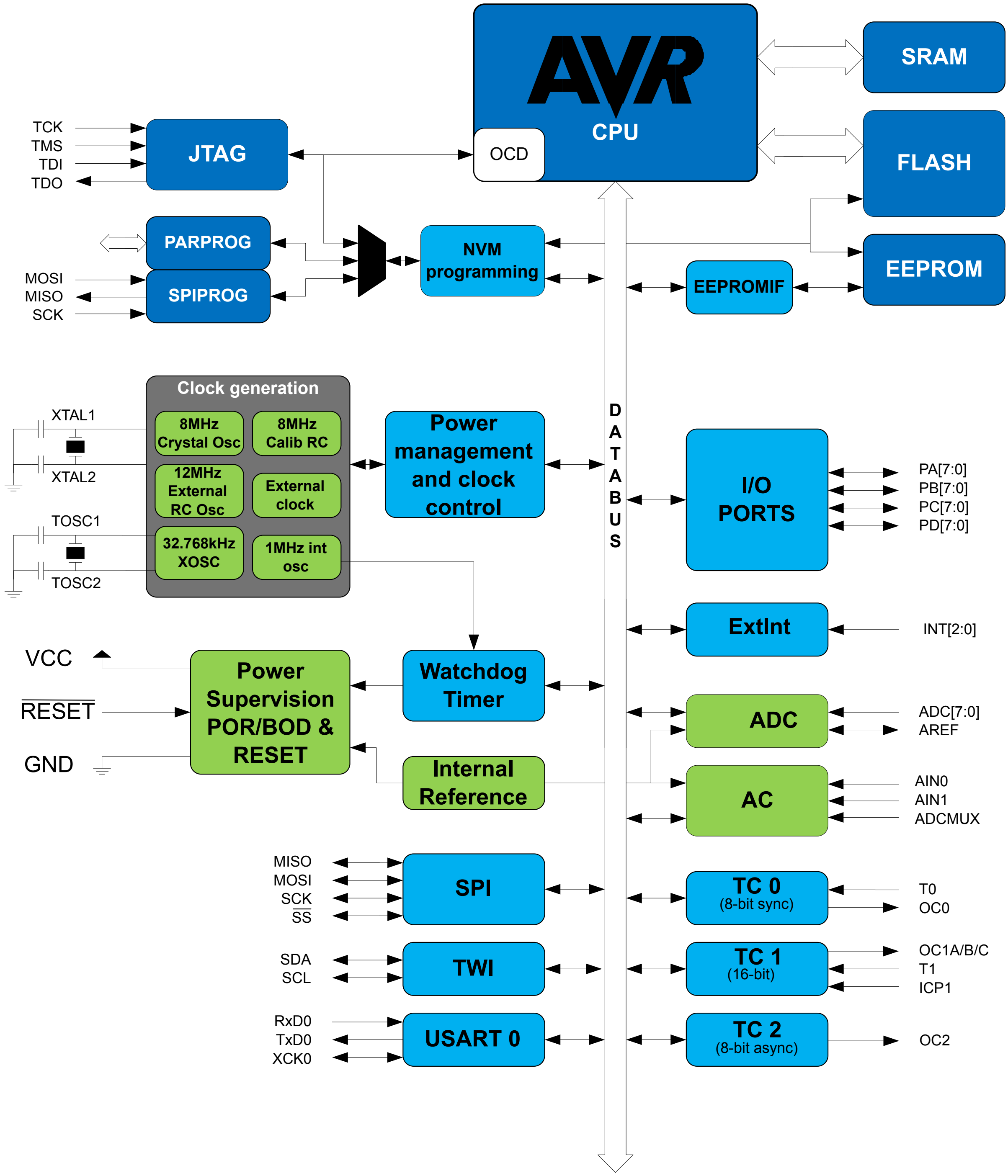
Note:

1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. Tape and Reel
4. See characterization specifications at 105°C

Package Type	
44A	44-lead, 10 × 10 × 1.0mm, Thin Profile Plastic Quad Flat Package (TQFP)
40P6	40-pin, 0.600” Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0mm, Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)

4. Block Diagram

Figure 4-1. Block Diagram



5. Pin Configurations

Figure 5-1. Pinout TQFP ATmega32A

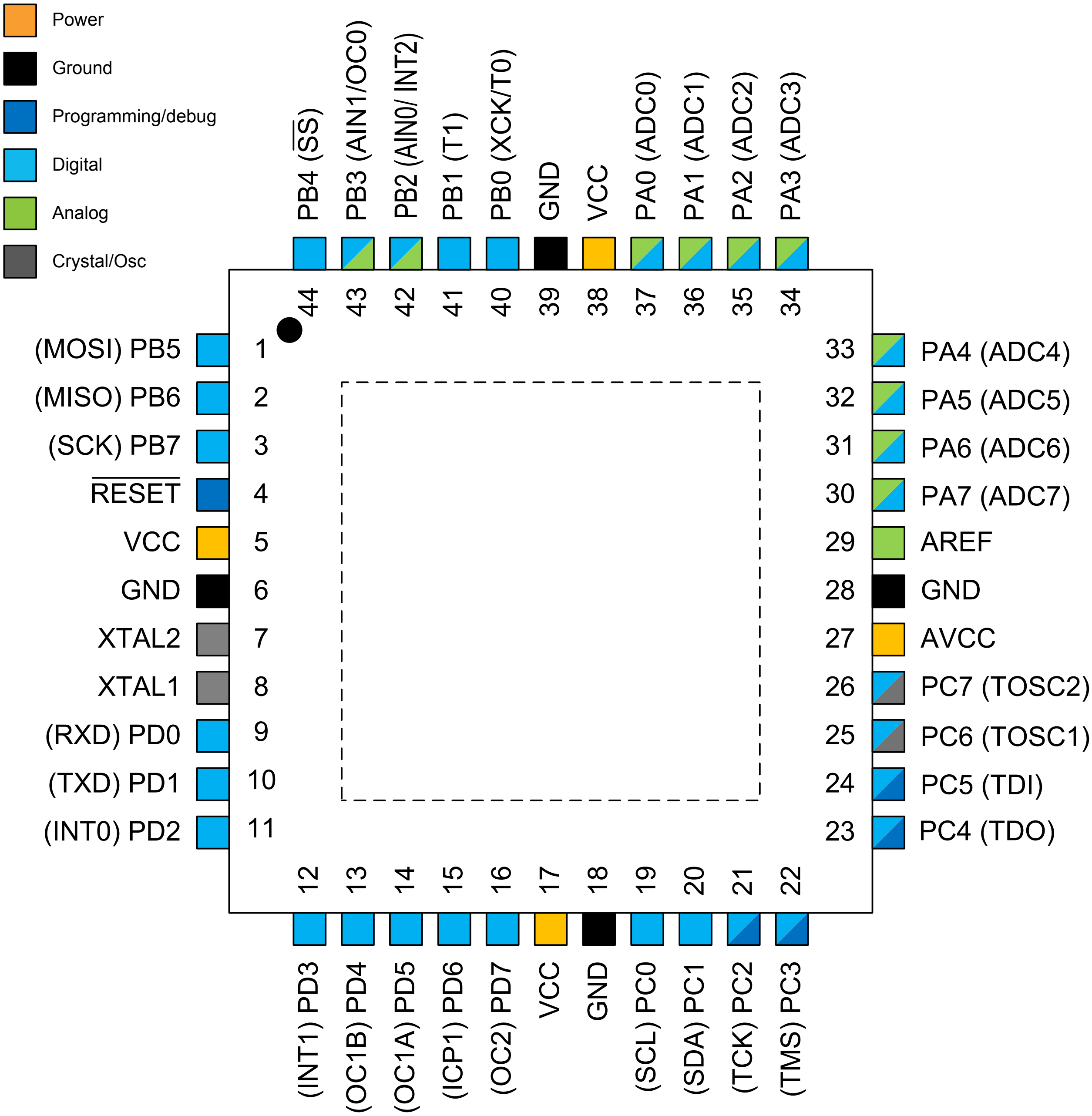
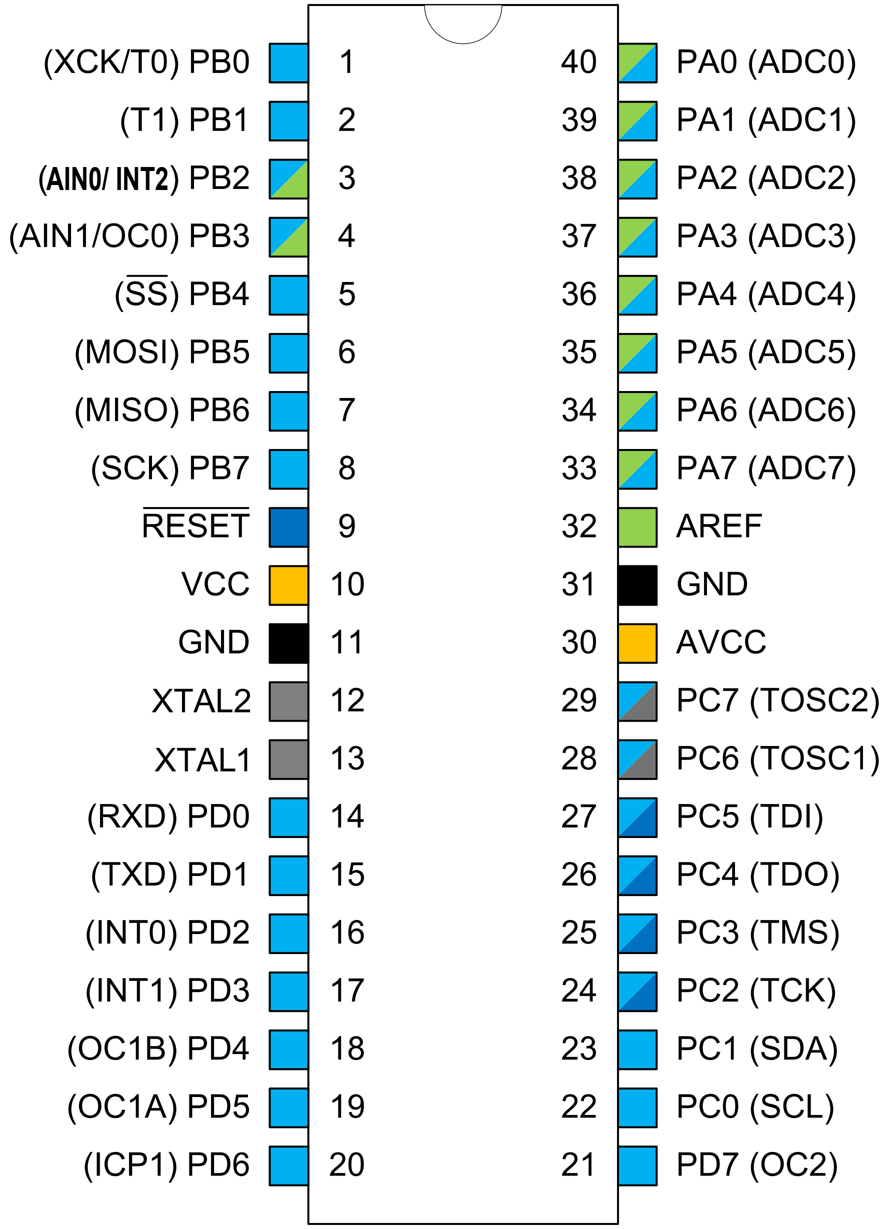


Figure 5-2. Pinout PDIP ATmega32A



5.1. V_{CC}

Digital supply voltage.

5.2. GND

Ground.

5.3. PortA (PA7:PA0)

Port A serves as the analog inputs to the A/D Converter.

Port A also serves as an 8-bit bi-directional I/O port, if the A/D Converter is not used. Port pins can provide internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. When pins PA0 to PA7 are used as inputs and are externally pulled low, they will source current if the internal pull-up resistors are activated. The Port A pins are tristated when a reset condition becomes active, even if the clock is not running.

5.4. Port B (PB7:PB0)

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tristated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the ATmega32A as listed in *Alternate Functions of Port B*.

5.5. Port C (PC7:PC0)

Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running. If the JTAG interface is enabled, the pull-up resistors on pins PC5(TDI), PC3(TMS) and PC2(TCK) will be activated even if a reset occurs.

The TD0 pin is tristated unless TAP states that shift out data are entered.

Port C also serves the functions of the JTAG interface and other special features of the ATmega32A as listed in *Alternate Functions of Port C*.

5.6. Port D (PD7:PD0)

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tristated when a reset condition becomes active, even if the clock is not running.

Port D also serves the functions of various special features of the ATmega32A as listed in *Alternate Functions of Port D*.

5.7. $\overline{\text{RESET}}$

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in *System and Reset Characteristics*. Shorter pulses are not guaranteed to generate a reset.

5.8. XTAL1

Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

5.9. XTAL2

Output from the inverting Oscillator amplifier.

5.10. AV_{CC}

AV_{CC} is the supply voltage pin for Port A and the A/D Converter. It should be externally connected to V_{CC}, even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter.

5.11. AREF

AREF is the analog reference pin for the A/D Converter.

6. Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.

7. Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.

8. About Code Examples

This datasheet contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Please confirm with the C compiler documentation for more details.

For I/O registers located in extended I/O map, “IN”, “OUT”, “SBIS”, “SBIC”, “CBI”, and “SBI” instructions must be replaced with instructions that allow access to extended I/O. Typically “LDS” and “STS” combined with “SBRS”, “SBRC”, “SBR”, and “CBR”.

9. Capacitive Touch Sensing

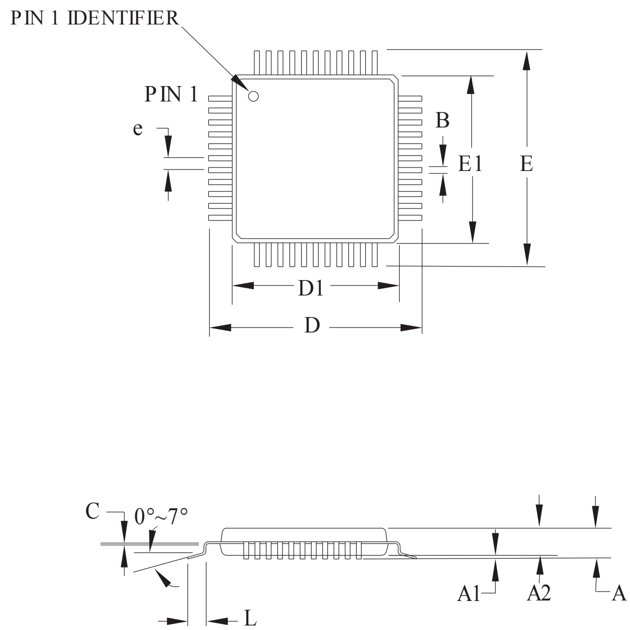
The Atmel QTouch Library provides a simple to use solution to realize touch sensitive interfaces on most Atmel AVR microcontrollers. The QTouch Library includes support for the QTouch and QMatrix® acquisition methods.

Touch sensing can be added to any application by linking the appropriate Atmel QTouch Library for the AVR Microcontroller. This is done by using a simple set of APIs to define the touch channels and sensors, and then calling the touch sensing API's to retrieve the channel information and determine the touch sensor states.

The QTouch Library is FREE and downloadable from the Atmel website at the following location: www.atmel.com/qtouchlibrary. For implementation details and other information, refer to the Atmel QTouch Library User Guide - also available for download from the Atmel website.

10. Packaging Information

10.1. 44-pin TQFP



COMMON DIMENSIONS
(Unit of Measure = mm)

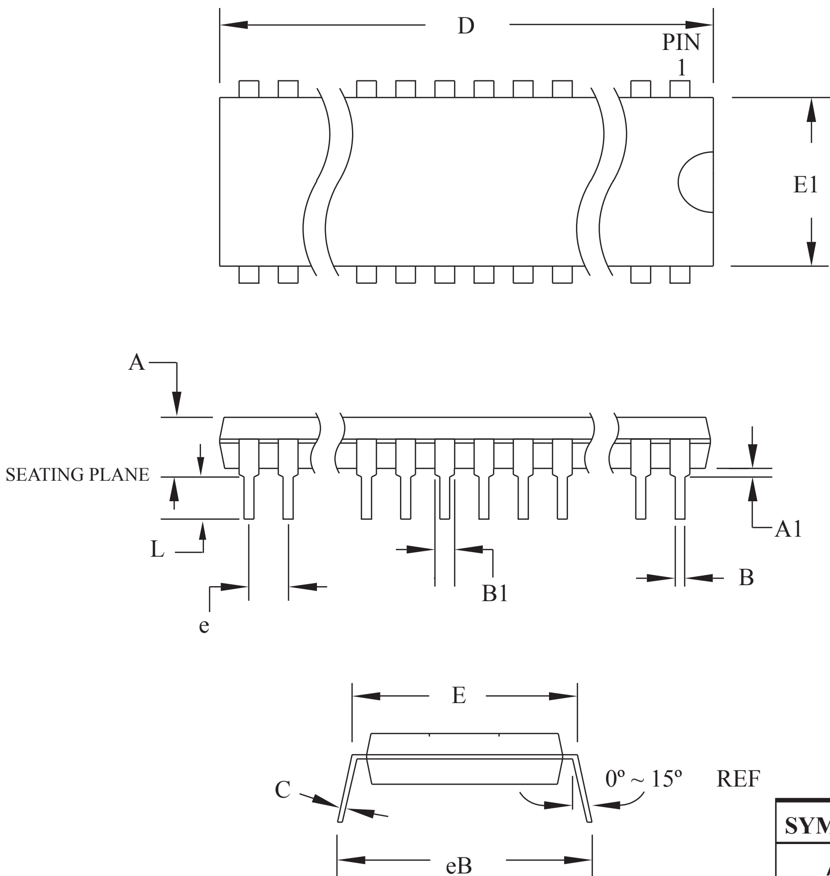
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
B	0.30	0.37	0.45	
C	0.09	(0.17)	0.20	
L	0.45	0.60	0.75	
e	0.80 TYP			

Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10mm maximum.

06/02/2014

	TITLE	DRAWING NO.	REV.
Atmel **Package Drawing Contact:** **packagedrawings@atmel.com**	**44A,** 44-lead, 10 x 10mm body size, 1.0mm body thickness, 0.8 mm lead pitch, thin profile plastic quad flat package (TQFP)	44A	C

10.2. 40-pin PDIP



COMMON DIMENSIONS
(Unit of Measure = mm)

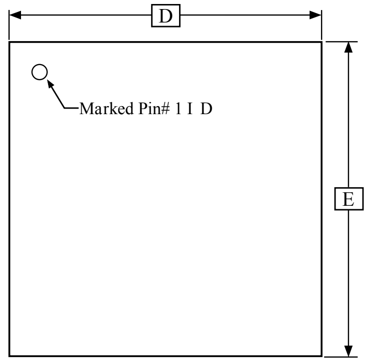
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	4.826	
A1	0.381	–	–	
D	52.070	–	52.578	Note 2
E	15.240	–	15.875	
E1	13.462	–	13.970	Note 2
B	0.356	–	0.559	
B1	1.041	–	1.651	
L	3.048	–	3.556	
C	0.203	–	0.381	
eB	15.494	–	17.526	
e	2.540 TYP			

Notes:
1. This package conforms to JEDEC reference MS-011, Variation AC.
2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25mm (0.010").

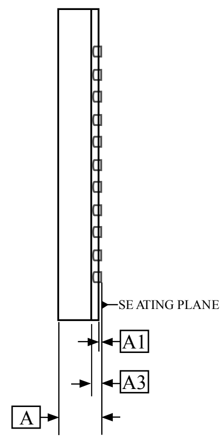
13/02/2014

	TITLE	DRAWING NO.	REV.
Atmel Package Drawing Contact: packagedrawings@atmel.com	**40P6**, 40-lead (0.600"/15.24mm Wide) Plastic Dual Inline Package (PDIP)	40P6	C

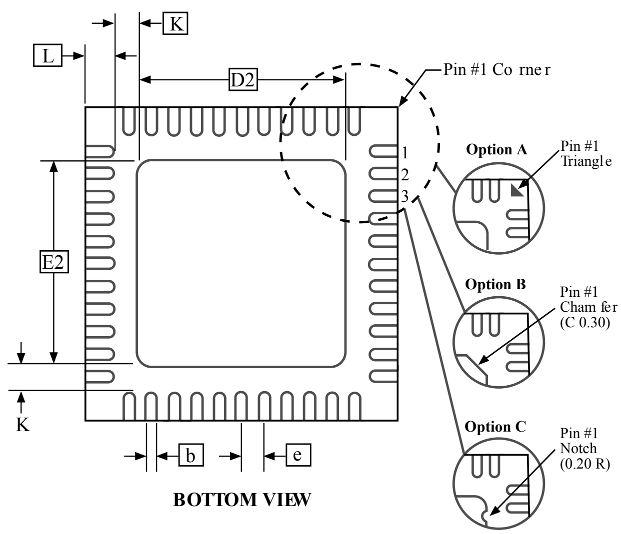
10.3. 44-pin VQFN



TOP VIEW



SIDE VIEW



BOTTOM VIEW

Note : JEDEC Standard MO-220, Fig . 1 (S AW Singulation) VKKD-3 .

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	–	0.02	0.05	
A3		0.20 REF		
b	0.18	0.23	0.30	
D	6.90	7.00	7.10	
D2	5.00	5.20	5.40	
E	6.90	7.00	7.10	
E2	5.00	5.20	5.40	
e		0.50 BSC		
L	0.59	0.64	0.69	
K	0.20	0.26	0.41	

9/26/08

	TITLE	GPC	DRAWING NO.	REV.
Atmel **Package Drawing Contact:** avr@atmel.com	**44M1,** 44-pad, 7 x 7 x 1.0mm body, lead pitch 0.50mm, 5.20mm exposed pad, thermally enhanced plastic very thin quad flat no lead package (VQFN)	ZWS	44M1	H

11. Errata

11.1. ATmega32A, rev. J to rev. K

- First Analog Comparator conversion may be delayed
- Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input
- Reading EEPROM by using ST or STS to set EERE bit triggers unexpected interrupt request.

1. **First Analog Comparator conversion may be delayed**

   If the device is powered by a slow rising V_{CC}, the first Analog Comparator conversion will take longer than
   expected on some devices.

   Problem Fix/Workaround

   When the device has been powered or reset, disable then enable the Analog Comparator before the first
   conversion.

2. **Interrupts may be lost when writing the timer registers in the asynchronous timer**

   The interrupt will be lost if a timer register that is synchronous timer clock is written when the asynchronous
   Timer/Counter register (TCNTx) is 0x00.

   Problem Fix/Workaround

   Always check that the asynchronous Timer/Counter register neither have the value 0xFF nor 0x00 before writing
   to the asynchronous Timer Control Register (TCCRx), asynchronous Timer Counter Register (TCNTx), or
   asynchronous Output Compare Register (OCRx).

3. **IDCODE masks data from TDI input**

   The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones
   during Update-DR.

   Problem Fix / Workaround

   - If ATmega32A is the only device in the scan chain, the problem is not visible.
   - Select the Device ID Register of the ATmega32A by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega32A while reading the Device ID Registers of preceding devices of the boundary scan chain.
   - If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega32A must be the fist device in the chain.

4. **Reading EEPROM by using ST or STS to set EERE bit triggers unexpected interrupt request.**

Reading EEPROM by using the ST or STS command to set the EERE bit in the EECR register triggers an unexpected EEPROM interrupt request.

Problem Fix / Workaround

Always use OUT or SBI to set EERE in EECR.

11.2. ATmega32A, rev. G to rev. I

- First Analog Comparator conversion may be delayed
- Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input
- Reading EEPROM by using ST or STS to set EERE bit triggers unexpected interrupt request.

1. **First Analog Comparator conversion may be delayed**

   If the device is powered by a slow rising V_{CC}, the first Analog Comparator conversion will take longer than expected on some devices.

   Problem Fix/Workaround

   When the device has been powered or reset, disable then enable the Analog Comparator before the first conversion.

2. **Interrupts may be lost when writing the timer registers in the asynchronous timer**

   The interrupt will be lost if a timer register that is synchronous timer clock is written when the asynchronous Timer/Counter register (TCNTx) is 0x00.

   Problem Fix/Workaround

   Always check that the asynchronous Timer/Counter register neither have the value 0xFF nor 0x00 before writing to the asynchronous Timer Control Register (TCCRx), asynchronous Timer Counter Register (TCNTx), or asynchronous Output Compare Register (OCRx).

3. **IDCODE masks data from TDI input**

   The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

   Problem Fix / Workaround

   – If ATmega32A is the only device in the scan chain, the problem is not visible.
   – Select the Device ID Register of the ATmega32A by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega32A while reading the Device ID Registers of preceding devices of the boundary scan chain.

– If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega32A must be the fist device in the chain.

4. **Reading EEPROM by using ST or STS to set EERE bit triggers unexpected interrupt request.**

   Reading EEPROM by using the ST or STS command to set the EERE bit in the EECR register triggers an
   unexpected EEPROM interrupt request.

   Problem Fix / Workaround

   Always use OUT or SBI to set EERE in EECR.

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